

# DF15005M - DF1510M

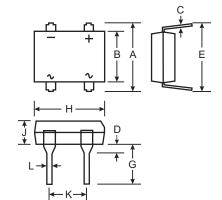
## 1.5A GLASS PASSIVATED BRIDGE RECTIFIERS

### **Features**

- Glass Passivated Die Construction
- Low Forward Voltage Drop, High Current Capability
- Surge Overload Rating to 50A Peak
- Designed for Printed Circuit Board Applications
- UL Listed Under Recognized Component Index, File Number E94661
- Lead Free Finish, RoHS Compliant (Date Code 0532+) (Note 3)

## **Mechanical Data**

- Case: DF-M
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Tin. Solderable per MIL-STD-202, Method 208 (e3)
- Polarity: As Marked on Case
- Marking: Type Number
- Weight: 0.38 grams (approximate)



DF-M						
Dim	Min Max					
Α	7.40	7.90				
В	6.20	6.50				
С	0.22 0.30					
D	1.27	2.03				
E	7.60	8.90				
G	3.81	4.69				
Н	8.13	8.51				
J	2.40	3.40				
K	5.00	5.20				
L	0.46	0.58				
All Dimensions in mm						

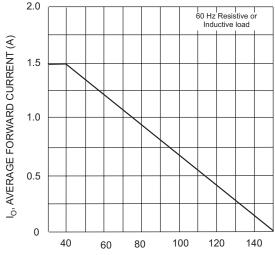
#### **Maximum Ratings and Electrical Characteristics** @ T<sub>A</sub> = 25°C unless otherwise specified

Single phase, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

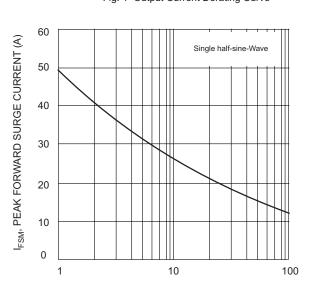
Characteristic		Symbol	DF 15005M	DF 1501M	DF 1502M	DF 1504M	DF 1506M	DF 1508M	DF 1510M	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	800	1000	٧
RMS Reverse Voltage		V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Average Rectified Output Current	@ T <sub>A</sub> = 40°C	Io	1.5					Α		
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load		I <sub>FSM</sub>	50					Α		
Forward Voltage (per element)	@ I <sub>F</sub> = 1.5A	V <sub>FM</sub>	FM 1.1				V			
Peak Reverse Current at Rated DC Blocking Voltage	@ T <sub>A</sub> = 25°C @ T <sub>A</sub> = 125°C	I <sub>RM</sub>	10 500			μΑ				
I <sup>2</sup> t Rating for Fusing (t<8.3ms)		I <sup>2</sup> t				10.4				A <sup>2</sup> s
Typical Total Capacitance (Note 2)		Ст	25					рF		
Typical Thermal Resistance Junction to Ambient		$R_{\theta JA}$	40					°C/W		
Operating and Storage Temperature Range		T <sub>j</sub> , T <sub>STG</sub>	-65 to +150				°C			

- Notes: 1. Thermal resistance from junction to ambient mounted on PC board with 13 x 13mm (0.03mm thick) land areas.
  - 2. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
  - 3. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.

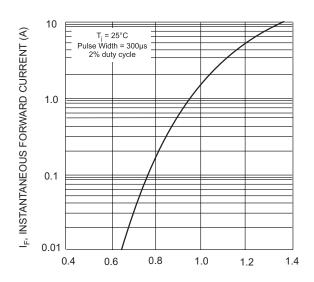




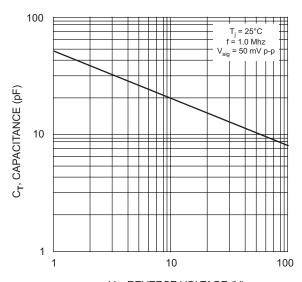
T<sub>A</sub>, AMBIENT TEMPERATURE (°C) Fig. 1 Output Current Derating Curve



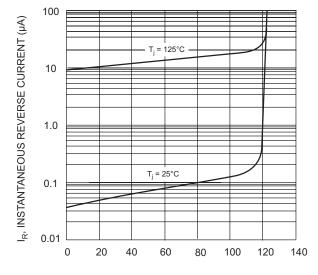
NUMBER OF CYCLES AT 60 Hz Fig. 3 Max Non-Repetitive Peak Forward Surge Current



V<sub>F</sub>, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typ Forward Characteristics (per element)



V<sub>R</sub>, REVERSE VOLTAGE (V)
Fig. 4 Typ Total Capacitance (per element)



PERCENT OF RATED PEAK REVERSE VOLTAGE (%) Fig. 5 Typ Reverse Characteristics (per element)



## **Ordering Information** (Note 4)

Device	Packaging	Shipping
DF15xxM	DF-M	50 per Tube

Notes: 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

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